In the Specification

Please replace the paragraph beginning on page 6, line 14 to page 7, line 3 with the following clean replacement paragraph.

Electrical connections 26 are provided along outer periphery 18 of substrate 14 and electrically contact conductive material 16. Electrical connections 26 are connected to a power source 28 which is also connected to polishing pad 22. Power source 28 forms a circuit which extends between polishing pad 22 and electrical connections 26 through conductive material 16, and which utilizes polishing pad 22 as an anode and connections 26 as a cathode. An electrolytic bath 30 is provided over conductive material 16 and between polishing bath 22 and electrical connections 26 to complete the electrical circuit. Electrolytic bath 30 can comprise, for example, an aqueous solution having salts dissolved therein. Bath 30 can also comprises comprise abrasive particles for utilization as polishing slurry during polishing of conductive material 16 with polishing pad 22.